

BETA PLUS

1. Characteristic

(1).Advanced process and material are transferred from the foreign country Transferred Materials and processes possess excellent carrying and brightness capacities, and have the outstanding low-zone leveling ability.

(2). Wide range of working temperature: good effect is achieved between 20-40 C.

(3). Brightening agent has the abilities of strong stability, easy operation and low consumtion.

2. Electroplating technology:

| Composition | Range | standard |
|--|-----------|----------|
| Copper sulfate CuSO45H | 160-220 | 200 |
| Sulphuric Acid H2SO4 (g/L) | 40-90 | 60 |
| Chloride Ion CL- (mg/L) | 40-100 | 60 |
| Beta plus Mu | 4-6 | 5 |
| Beta plus A | 0.4-0.6 | 0.5 |
| Beta plus B | 0.3-0.5 | 0.4 |
| Temperature (°C) | 20-40 | 28 |
| Anode Current Density (A/dm ²) | 1-6 | |
| Cathode Current Density | 1.5-8 | |
| (A/dm²) | | |
| Mixing | Air | |
| | agitation | |
| Voltage (V) | 3-9 | |

3. Plating solution process:

(1). Fill in 2/3 DI water into the preparation channel. (Please note: Prior to this step

The water must be checked for the presence of chloride ion .

- (2). Add in the Copper Sulfate, required in the start quantity, and stir quantity, and Stir them to be dissolved.
- (3). Add in the wanted Analytic Reagent Sulphuric Acid.
- (4). Add in Activated Carbon (5g/L) and stir for 4 hours, and then perform filteration after static precipitatin.
 - (5). Add in Chloride Ion and additive, required in the start quantity, after 8hours electrolysis
 - (6). Start production stage after trial plating is normal.
 - 4. Method to solve beta plus problems:

| problem | cause | Solution |
|--|--|---|
| | 1.copper content is too low | 1. analyze it and increase content |
| Burn easily for plating layer | 2.current density is too high | 2.raise the channel temperature |
| | 3. channel solution temperature is too low | 3. raise the channel temperature |
| | 4.Chloride ion content is too low | 4. analyze it and Chloride ion |
| poor dispersibility of plating layer | 1.current is too low 2.sulphuric acid content is low 3.chloride ion content is high 4.channel temperature is high 5.beta plus B is too much, but beta plus A is too little | 1.adjust current 2.analyze it and add sulphuric acid 3.lower the content of chloride ion 4.reduce the temperature of channel 5.add beta plus A properly |

| Good plating | 1.organic impurity is too | 1.treat it by hydrogen peroxide, activated |
|-------------------|--------------------------------|--|
| layer, but there | much | carbon |
| are pinholes and | | 2.add them properly |
| pockmarks | 2.too little beta plus Bor too | 3.reduce filter pore size |
| | little Mu | |
| | 3.filltration is not enough | |
| Branching | Too much beta plus B or too | 1. Add beta plus B to adjust it, or add a |
| treelike shape or | little beta plus B | little hydrogen peroxide. |
| stripe on the | 2. Chloride ion is not enough. | 2.increase chloride ion |
| plating layer | | |
| | 1.imbalance in the | 1.brightening agent proportion |
| | proportion of brightening | |
| Poor | agent | 2.treat it by hydrogen peroxide, |
| brightness | 2.organic impurity is too | Activate carbon |
| | much | 3. Lower temperature. |
| | | 4.increase anodic area |
| | 3.channel temperature is | 5.raise current appropriately |
| | high | |
| | 4. anodic area is not big | |
| | enough | |
| | 5.current is too low | |
| Bad Levelling of | 1.copper sulfate content is | 1.anlyze it and add copper sulfate |
| plating layer | low | 2.increse beta plus A |
| | 2.too little beta plus A | 3.add beta plus Mu |
| | 3.too little beta plus Mu | 4.analyze it and add chloride ion |
| | 4.chloride ion content is low | |
| Not bright on the | 1.chloride ion content is too | 1.analyze it and treat it |
| plating layer and | high | 2.add it appropriately |
| fog | 2.critically insufficient beta | 3.treat |
| | plus Mu | It by hydrogen peroxide, activated carbon |
| | 3.too much beta plus Mu | |
| | | |

5. The adding method of additive

Beta Plus Mu starter: Used for the start or channel change, to support beta plus A, beta plus B, to make the strong

Leveling and brightness plating layer, and remove pinholes.

Beta plus A leveling agent: Used to make low-zone to get the good leveling and gloss effect, and improve

The whole leveling effect.

Beta plus B bright agent: Used to prevent high-zone from burned, and make plating layer brighter, so as to gain the strong leveling and excellent brightness effect.

6. Consumption: calculated per kiloampre .hour

Beta Plus : 50-70 m1/kiloampre .hour

Beta plus B :50-70 m1/kiloampere .hour

Beta plus Mu Approximately 5%A+B gross consumption. it is generally unnecessary to add it in the daily production. Every time increase 1 kg copper sulfate, and then add in 15-20 ml